



#### 20V P-CHANNEL ENHANCEMENT MODE MOSFET POWERDI<sup>®</sup>

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>C</sub> = +25°C		
-20V	$5.5$ m $\Omega$ @ V <sub>GS</sub> = -4.5V	-40A		
-200	$7.5 \text{m}\Omega$ @ $V_{GS} = -2.5V$	-40A		

### **Description**

This MOSFET is designed to minimize the on-state resistance (RDS(on)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

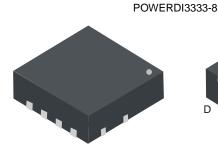
- Load Switch
- **Power Management Functions**

### **Features**

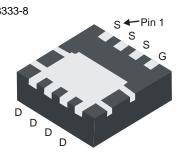
- Low R<sub>DS(ON)</sub> ensures on state losses are minimized
- Small form factor, thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

### **Mechanical Data**

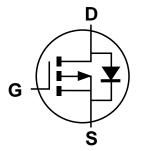
- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)







**Bottom View** 



**Equivalent Circuit** 

### **Ordering Information** (Note 4)

h <del>.</del>		
Part Number	Case	Packaging
DMP2006UFG-7	POWERDI3333-8	2,000/Tape & Reel
DMP2006UFG-13	POWERDI3333-8	3.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

POWERDI3333-8



S47 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 13 = 2013)WW = Week Code (01 ~ 53)



## **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			$V_{DSS}$	-20	V
Gate-Source Voltage			$V_{GSS}$	±10	V
Continuous Drain Current (Note 5) $V_{GS}$ = -4.5V Steady State $T_A$ = +25°C $T_C$ = +25°C $T_C$ = +25°C		I <sub>D</sub>	-17.5 -14.0 -40	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	-80	Α		
Maximum Continuous Body Diode Forward Current (Note 5)			Is	-2.2	Α
Avalanche Current (Note 7) L=0.1mH			I <sub>AS</sub>	-23	Α
Avalanche Energy (Note 7) L=0.1mH			E <sub>AS</sub>	28	mJ

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Bower Dissinction (Note 5)	$T_A = +25^{\circ}C$	ם	2.3	- W
Total Power Dissipation (Note 5)	$T_C = +25$ °C	$P_{D}$	41	
Thermal Resistance, Junction to Ambient	(Note 5)	D	54	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	136	
Thermal Resistance, Junction to Case (Note 5)	R <sub>0</sub> JC	3.0		
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to +150	°C	

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

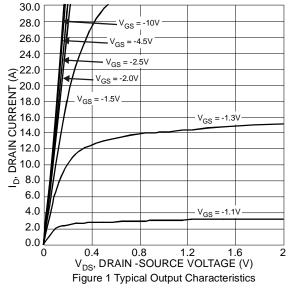
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	1	_	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	l	1	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	-0.4	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		_	4.2	5.5		$V_{GS} = -4.5V$ , $I_{D} = -15A$	
Static Drain-Source On-Resistance	D	_	5.4	7.5	mΩ	$V_{GS} = -2.5V$ , $I_{D} = -10A$	
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>	l	8	12	11177	$V_{GS} = -1.8V, I_{D} = -1A$	
		1	12	17		$V_{GS} = -1.5V, I_{D} = -1A$	
Diode Forward Voltage	$V_{SD}$	1	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -10A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	5404	7500		V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V f = 1.0MHz	
Output Capacitance	Coss	-	728	1000	pF		
Reverse Transfer Capacitance	Crss		612	900			
Gate Resistance	$R_{G}$	l	3.8	8	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	1	64	100			
Total Gate Charge (V <sub>GS</sub> = -10V)	$Q_g$	l	140	200	nC	V <sub>DD</sub> = -10V. I <sub>D</sub> = -20A	
Gate-Source Charge	$Q_{gs}$		8.5	15	IIC	VDD = -10V, ID = -20A	
Gate-Drain Charge	$Q_{gd}$	_	17	30			
Turn-On Delay Time	t <sub>D(on)</sub>	_	9.1	20		$V_{GS} = -4.5V, V_{DD} = -10V,$ $R_{G} = 1\Omega, R_{G} = 1\Omega, I_{D} = -10A$	
Turn-On Rise Time	t <sub>r</sub>	_	19	35			
Turn-Off Delay Time	t <sub>D(off)</sub>		146	220	ns		
Turn-Off Fall Time	t <sub>f</sub>	_	104	150	1		
Reverse Recovery Time (Note 9)	t <sub>rr</sub>	1	61	100	ns	I <sub>F</sub> = -10A, di/dt = 100A/μs	
Reverse Recovery Charge (Note 9)	Q <sub>rr</sub>	_	44	70	nC	I <sub>F</sub> = -10A, di/dt = 100A/μs	

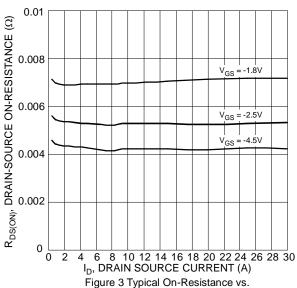
Notes:

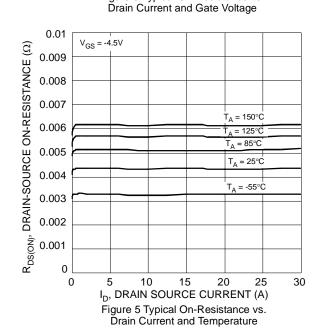
- 5. R<sub>BJA</sub> is determined with the device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. R<sub>BJC</sub> is guaranteed by design while R<sub>BJA</sub> is determined by the user's board design.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7 .UIS in production with L =0.1mH,  $T_J$  = +25°C
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

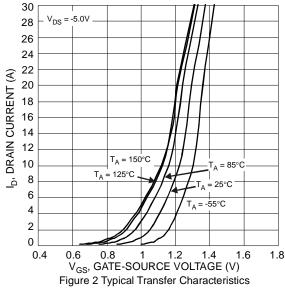


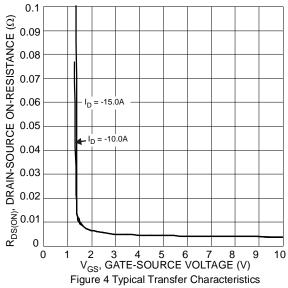












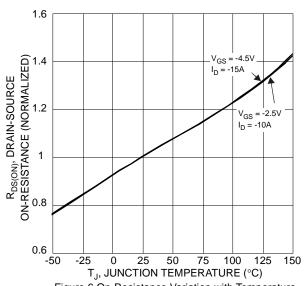
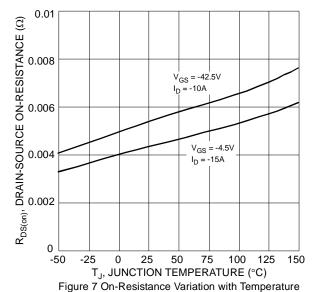
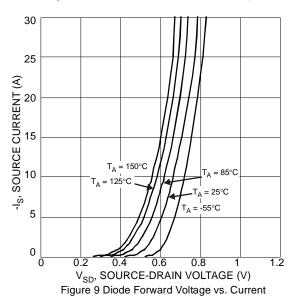
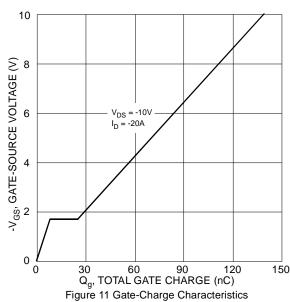


Figure 6 On-Resistance Variation with Temperature









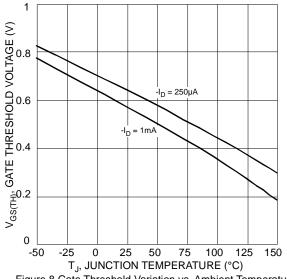
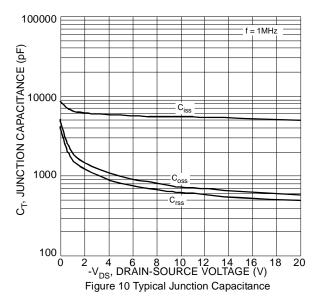
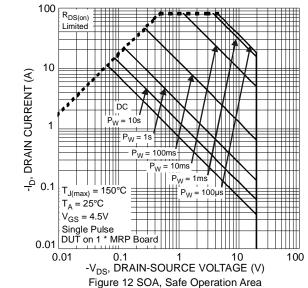
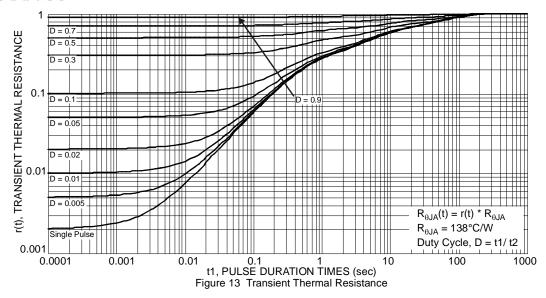


Figure 8 Gate Threshold Variation vs. Ambient Temperature



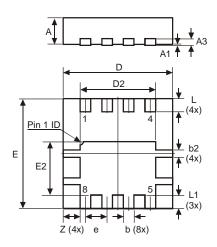






## **Package Outline Dimensions**

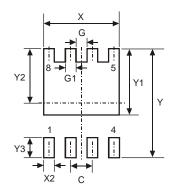
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI3333-8					
Dim	Min	Max	Тур		
D	3.25	3.35	3.30		
Е	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E2	1.56	1.66	1.61		
Α	0.75	0.85	0.80		
A1	0	0.05	0.02		
А3	_	_	0.203		
b	0.27	0.37	0.32		
b2	_	_	0.20		
L	0.35	0.45	0.40		
L1	-	-	0.39		
е	_	_	0.65		
Z	-	_	0.515		
All Dimensions in mm					

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	0.650		
G	0.230		
G1	0.420		
Υ	3.700		
Y1	2.250		
Y2	1.850		
Y3	0.700		
X	2.370		
X2	0.420		



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